- *EPIC* [™] (Enhanced-Performance Implanted CMOS) Process
- Typical V_{OLP} (Output Ground Bounce) < 0.8 V at V_{CC}, T_A = 25°C
- Typical V_{OHV} (Output V_{OH} Undershoot)
 > 2 V at V_{CC}, T_A = 25°C
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Package Options Include Plastic Small-Outline (DW, NS), Shrink Small-Outline (DB), Thin Very Small-Outline (DGV), and Thin Shrink Small-Outline (PW) Packages, Ceramic Flat (W) Packages, Chip Carriers (FK), and DIPs (J)

description

These octal buffers/line drivers are designed for 2-V to 5.5-V $\rm V_{CC}$ operation.

The 'LV244A devices are designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters.

These devices are organized as two 4-bit line drivers with separate output-enable (\overline{OE}) inputs. When \overline{OE} is low, the device passes data from the A inputs to the Y outputs. When \overline{OE} is high, the outputs are in the high-impedance state.

SN54LV244A J OR W PACKAGE
SN74LV244A DB, DGV, DW, NS, OR PW PACKAGE
(TOP VIEW)

	(101	vi L vv)	
1OE [1A1 [2Y4 [1A2 [2Y3 [1A3 [2Y2 [1A4 [2Y1 [5 6 7 8 9	20 19 18 17 16 15 14 13	V _{CC} 2OE 1Y1 2A4 1Y2 2A3 1Y3 2A2 1Y4
GND [10	11	2A1

SN54LV244A . . . FK PACKAGE (TOP VIEW)

	2Y4 1A1 V _{CC} 2 <u>0E</u>	
1A2 2Y3	3 2 1 20 19 4 18	1Y1
2Y3	5 17	2A4
1A3	6 16	1Y2
2Y2 1A4	7 15	2A3
1A4	8 14	1Y3
	9 10 11 12 13	
	2Υ1 GND 2A1 1Y4 2A2	

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54LV244A is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74LV244A is characterized for operation from –40°C to 85°C.

FUNCTION TABLE (each buffer)								
INPUTS OUTPUT								
OE	Α	Y						
L	Н	Н						
L	L	L						
н	Х	Z						



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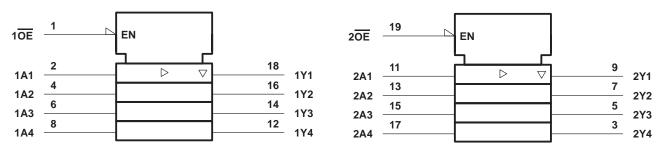


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SN54LV244A, SN74LV244A OCTAL BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

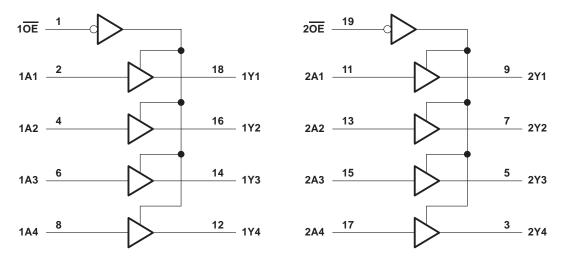
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logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[‡]

Storage temperature range, T _{stg}	Input voltage range, V _I (see Note 1) Output voltage range applied in the high or low Output voltage range applied in high-impedance Input clamp current, I _{IK} (V _I < 0) Output clamp current, I _{OK} (V _O < 0 or V _O > V _{CC} Continuous output current, I _O (V _O = 0 to V _{CC}) Continuous current through V _{CC} or GND Package thermal impedance, θ_{JA} (see Note 3):	-0.5 V to 7 V -0.5 V to 7 V state, V _O (see Notes 1 and 2) -0.5 V to V _{CC} + 0.5 V or power-off state, V _O (see Note 1) -0.5 V to 7 V -20 mA -20 mA ±50 mA ±35 mA ±70 mA DB package 115°C/W DGV package 97°C/W NS package 100°C/W PW package 128°C/W
	Storage temperature range, T _{stg}	

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. This value is limited to 7 V maximum.

3. The package thermal impedance is calculated in accordance with JESD 51.



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recommended operating conditions (see Note 4)

			SN54L	SN54LV244A		V244A	UNIT	
			MIN MAX		MIN	MAX	UNIT	
VCC	Supply voltage		2	5.5	2	5.5	V	
		V _{CC} = 2 V	1.5		1.5			
\ <i>\</i>	Lligh lovel input veltage	V_{CC} = 2.3 V to 2.7 V	$V_{CC} \times 0.7$		$V_{CC} \times 0.7$		V	
VIH	High-level input voltage	$V_{CC} = 3 V \text{ to } 3.6 V$	$V_{CC} \times 0.7$		$V_{CC} \times 0.7$		v	
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	$V_{CC} \times 0.7$		$V_{CC} \times 0.7$			
		$V_{CC} = 2 V$		0.5		0.5		
V.		V_{CC} = 2.3 V to 2.7 V		VCC×0.3		$V_{CC} \times 0.3$	v	
VIL	Low-level input voltage	$V_{CC} = 3 V \text{ to } 3.6 V$,	V _{CC} ×0.3		$V_{CC} \times 0.3$	v	
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$,	VCC×0.3		$V_{CC} \times 0.3$		
VI	Input voltage		0	5.5	0	5.5	V	
Ma		High or low state	0	Vcc	0	VCC	V	
VO	Output voltage	3-state	0	\$ 5.5	0	5.5	v	
		$V_{CC} = 2 V$		S –50		-50	μΑ	
la.	Lick lovel output ourrest	V_{CC} = 2.3 V to 2.7 V	20	-2		-2		
юн	High-level output current	V _{CC} = 3 V to 3.6 V	2	-8		-8	mA	
		V _{CC} = 4.5 V to 5.5 V		-16		-16		
		V _{CC} = 2 V		50		50	μΑ	
1		V_{CC} = 2.3 V to 2.7 V		2		2		
IOL	Low-level output current	V _{CC} = 3 V to 3.6 V		8		8	mA	
		V _{CC} = 4.5 V to 5.5 V		16		16		
		V _{CC} = 2.3 V to 2.7 V	0	200	0	200		
$\Delta t/\Delta v$	Input transition rise or fall rate	V _{CC} = 3 V to 3.6 V	0	100	0	100	ns/V	
		V _{CC} = 4.5 V to 5.5 V	0	20	0	20	1	
Тд	Operating free-air temperature		-55	125	-40	85	°C	

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



SN54LV244A, SN74LV244A **OCTAL BUFFERS/DRIVERS** WITH 3-STATE OUTPUTS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		SN54LV244A	SN74LV244A	UNIT	
PARAMETER	TEST CONDITIONS	Vcc	MIN TYP MAX	MIN TYP MAX	UNIT	
	I _{OH} = -50 μA	2 V to 5.5 V	V _{CC} -0.1	V _{CC} -0.1		
Mari	$I_{OH} = -2 \text{ mA}$	2.3 V	2	2	V	
VOH	I _{OH} = -8 mA	3 V	2.48	2.48	v	
	I _{OH} = -16 mA	4.5 V	3.8	3.8		
	I _{OL} = 50 μA	2 V to 5.5 V	J 0.1	0.1		
No.	I _{OL} = 2 mA	2.3 V	0.4	0.4	v	
VOL	I _{OL} = 8 mA	3 V	0.44	0.44	v	
	I _{OL} = 16 mA	4.5 V	0.55	0.55		
lլ	$V_{I} = V_{CC}$ or GND	5.5 V	6 ±1	±1	μΑ	
IOZ	$V_{O} = V_{CC} \text{ or } GND$	5.5 V	2 ±5	±5	μΑ	
ICC	$V_{I} = V_{CC} \text{ or } GND, \qquad I_{O} = 0$	5.5 V	20	20	μΑ	
loff	V_{I} or V_{O} = 0 to 5.5 V	0 V	20	20	μΑ	
<u> </u>		3.3 V	2.3	2.3	pF	
Ci	$V_I = V_{CC}$ or GND	5 V	2.3	2.3	μr	

switching characteristics over recommended operating free-air temperature range, $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$ (unless otherwise noted) (see Figure 1)

DADAMETED	PARAMETER FROM TO LOAD		T,	ן = 25°C	;	SN54L	V244A	SN74L	V244A	UNIT	
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
^t pd*	A	Y			7.5	12.5	1	15	1	15	
t _{en} *	OE	Y	C _L = 15 pF		8.9	14.6	1	17	1	17	ns
^t dis [*]	OE	Y			9.1	14.1	1	4 16	1	16	
^t pd	A	Y			9.5	15.3	1	18	1	18	
ten	OE	Y	$C_{1} = 50 \text{ pF}$		10.8	17.8	$\eta_{\mathcal{T}_{\mathcal{C}}}$	21	1	21	-
^t dis	OE	Y	CL = 50 pF		13.4	19.2	Q1	21	1	21	ns
^t sk(o) [†]						2	Q			2	

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

[†] Skew between any two outputs of the same package switching in the same direction

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V ± 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	PAMETED FROM TO LOAD		Т	_ = 25°C	;	SN54L	V244A	SN74L	V244A	UNIT	
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
^t pd*	A	Y			5.4	8.4	1	10	1	10	
t _{en} *	OE	Y	C _L = 15 pF		6.3	10.6	1	12.5	1	12.5	ns
^t dis [*]	OE	Y			7.6	11	1	2 13	1	13	
^t pd	A	Y			6.8	11.9	1/	13.5	1	13.5	
ten	OE	Y	C. 50 pF		7.8	14.1	240	16	1	16	
^t dis	OE	Y	CL = 50 pF		11	16	01	18	1	18	ns
^t sk(o) [†]						1.5	Q			1.5	

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

[†] Skew between any two outputs of the same package switching in the same direction

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switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	LOAD	Τį	ן = 25°C	;	SN54L	V244A	SN74L	/244A	UNIT
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
^t pd*	A	Y			3.9	5.5	1	6.5	1	6.5	
t _{en} *	OE	Y	C _L = 15 pF		4.5	7.3	1	8.5	1	8.5	ns
^t dis [*]	OE	Y			6.5	12.2	1	13.5	1	13.5	
^t pd	A	Y			4.9	7.5	1	8.5	1	8.5	
t _{en}	OE	Y	$C_{1} = 50 \text{ pF}$		5.6	9.3	η_{c}	10.5	1	10.5	-
^t dis	OE	Y	C _L = 50 pF		8.8	14.2	01	15.5	1	15.5	ns
^t sk(o) [†]						1	2			1	

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

[†] Skew between any two outputs of the same package switching in the same direction

noise characteristics, V_{CC} = 3.3 V, C_L = 50 pF, T_A = 25°C (see Note 5)

	PARAMETER	SN	74LV244	A	UNIT
	FARAMETER	MIN	TYP	MAX	UNIT
V _{OL(P)}	Quiet output, maximum dynamic V _{OL}		0.55		V
V _{OL(V)}	Quiet output, minimum dynamic V _{OL}		-0.5		V
VOH(V)	Quiet output, minimum dynamic V _{OH}		2.9		V
VIH(D)	High-level dynamic input voltage	2.31			V
VIL(D)	Low-level dynamic input voltage			0.99	V

NOTE 5: Characteristics are for surface-mount packages only.

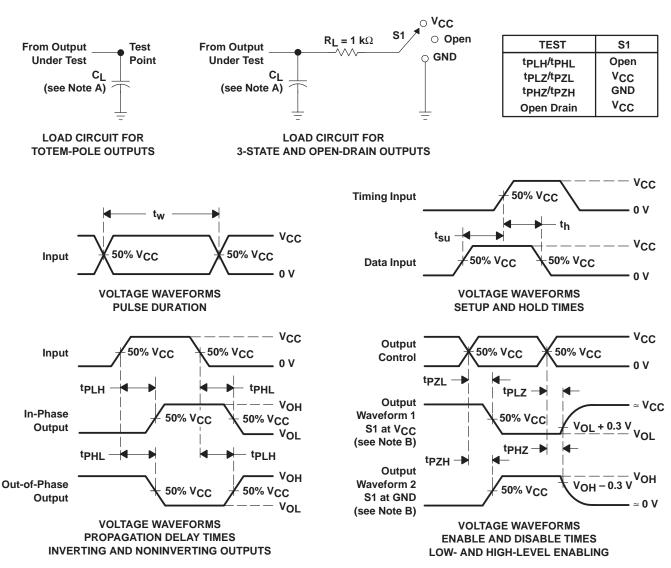
operating characteristics, $T_A = 25^{\circ}C$

	PARAMETER		TEST CONDITIONS			UNIT
Card	Power dissipation capacitance	$C_1 = 50 \text{pF}$	f = 10 MHz	3.3 V	14	рF
Cpd		CL = 50 pr,	1 - 10 10112	5 V	16	ρı



SN54LV244A, SN74LV244A **OCTAL BUFFERS/DRIVERS** WITH 3-STATE OUTPUTS

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PARAMETER MEASUREMENT INFORMATION

NOTES: A. C_I includes probe and jig capacitance.

B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , t_f \leq 3 ns, t_f \leq 3 ns.
- D. The outputs are measured one at a time with one input transition per measurement.
- E. tpl 7 and tpH7 are the same as tdis.

F. tpzL and tpzH are the same as ten.

G. tPHL and tPLH are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms



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